TYS8040150M-10

PHYSICAL DIMENSIONS:

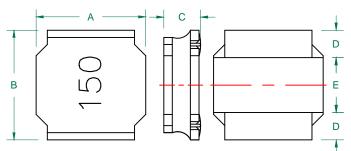
 $A 8.00 \pm 0.30$

 $B 8.00 \pm 0.30$

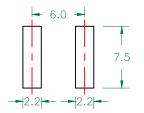
C 4.20 MAX.

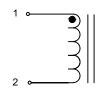
D 2.00 ± 0.30

 $E 4.00 \pm 0.30$



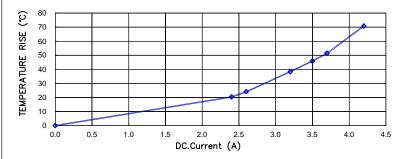
LAND PATTERNS FOR REFLOW SOLDERING



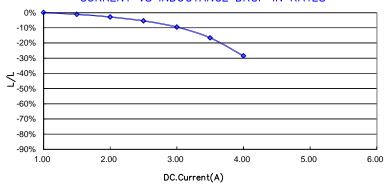




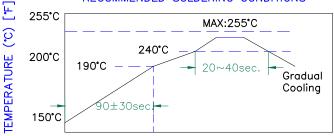
CHARACTERISTICS OF TEMPERATURE RISE



CURRENT VS INDUCTANCE DROP IN RATES



RECOMMENDED SOLDERING CONDITIONS



ELECTRICAL SPECIFICATION

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 20%	12.0	15.0	18.0
DCR (Ω)		0.047	0.0611

Saturation Current(A)	2.95
SRF (MHz)	12
Temperature Rise Current (A)	2.60

NOTES: UNLESS OTHERWISE SPECIFIED

1.OPERATING TEMPERATURE RANGE: -40°C TO +125°C (INCLUDING SELF-HEATING) .

2.STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)

3.UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS: A. AMBIENT TEMPERATURE: 20±15°C.

B. RELATIVE HUMIDITY: 65%±20%.

4.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS ≤30% FROM ITS VALUE WITHOUT CURRENT.

5.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta \text{T} \leq 40\,^{\circ}\text{C}$) FROM 20°C AMBIENT.

	DIMENSIONS ARE IN mm . This print is the property of Laird Tech, and is loaned in confidence			rd				
				subject to return upon request			=	
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				written consent of Laird Tech. A	ji 🗀			
				rights to design or invention are reserved.	•			
				PROJECT/PART NUMBER:	_—	_		
				PROJECT/PART NUMBER:	REV	PART T		DRAWN BY:
		<u> </u>		TYS8040150M-10	l B		WER	QIU
						INDU	JCTOR	4
В	CHANGE TEMP. FROM −25°C~+125°C	12/26/12	QIU	DATE: 06/01/12 SC CAD # TO		NTS	SHEET:	•
Α	ORIGINAL DRAFT	06/01/12	QIU					
REV	DESCRIPTION	DATE	INT		TOOL #	-	1	of 1